

Data issued: July 7, 2021
Valid period: 12 months

Bulletin

We, CHIMEI CORPORATION, to the best of our knowledge hereby certify that the resins listed below (hereinafter referred as "products") as directly manufactured by us

WONDERLITE® PC PC-108U, PC-110(U), PC-110L, PC-110V, PC-115(U), PC-115P, PC-115P F01, PC-115P F17111C1, PC-122(U), PC-145K, PC-145K F01, PC-175, PC-616LS, PC-681U, PC-6015, PC-6500, PC-6510, PC-6600, PC-6600 J01, PC-6610, PC-6610 J01, PC-6620, PC-6700, PC-6710, PC-6715VT, FC-910, FC-975

WONDERLOY® PC Alloy PC-330, PC-345, PC-365, PC-385, PC-510, PC-540(A), PC-540(A) J01, PC-540, PC-540 J01, PC-540 J09, PC-540H, PC-541

contain no following substances.

1. Halogen (Br, I) and its compounds
2. Halogen (Cl)
3. PBDEs (Polybrominated Diphenyl Ethers)
4. PBBs (Polybrominated Biphenyls)
5. Ozone Depleting Chemicals (CFCs & HCFCs)
6. Chlorinated Paraffin (C10-C13)
7. Polyvinyl Chloride (PVC)
8. Mercury (Hg) and its compounds
9. Lead (Pb) and its compounds
10. Cadmium (Cd) and its compounds
11. Chromium (Cr) and its compounds
12. Arsenic (As) and its compounds
13. Antimony (Sb) and its compounds
14. Selenium (Se) and its compounds
15. Barium (Ba) and its compounds
16. Beryllium (Be) and its compounds
17. Bismuth (Bi) and its compounds
18. Organic tin compounds (TBT, TPT, DOT, DBT...etc)
19. Polychlorinated Biphenyls (PCBs) and Terphenyls (PCTs) and Napthalenes (PCNs)
20. Poly naphthalenes
21. Azo colorants (according to REACH-ANNEX-XVII-APPENDIX 8)
22. Asbestos
23. Phthalates
24. APEO: Including Alkylphenol(AP), Octylphenol(OP), Nonylphenol(NP), Octylphenol ethoxylates(OPE), Nonylphenol ethoxylates(NPE)
27. Dimethylfumarate (DMF)
28. Triclosan
29. Nickel
30. PAHs (Polycyclic Aromatic Hydrocarbons)
31. REACH- Candidate List of SVHC
32. Radioactive Substances
33. Natural Latex
34. Dioxins and furans
35. Primary aromatic amines (PAA)
36. Perchlorate
37. Hexachlorobenzene
38. Mirex
39. Specified amine compounds
40. Benzene
41. Benzenamine, *N*-phenyl-, Reaction Products with Styrene and 2,4,4-Trimethylpentene (BNST)
42. Polyamide
43. PVDC (polyvinylidene chloride)
44. ESBO (Expoxidized soybean oil)
45. Formamide
46. Hexabromocyclododecane (HBCDD)
47. Red phosphorus
48. Aniline · formaldehyde polycondensate
49. Chlorobenzene
50. 4,4'-Sulfonyldiphenol (BPS)
51. Cobalt
52. PIP (3:1) (phenol, isopropylated phosphate 3:1)
53. DecaBDE (decabromodiphenyl ether)
54. 2,4,6-TTBP (2,4,6-Tris(tert-butyl)phenol)
55. HCBd (hexachlorobutadiene)

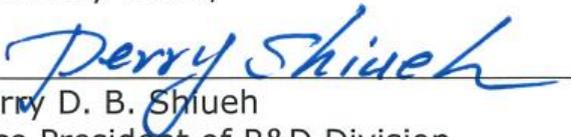
The above statement is based on our current level of knowledge and covers the above products directly manufactured and supplied by CHIMEI CORPORATION at the date of issue. CHIMEI CORPORATION makes no warranties, whether express or implied, and assumes no liability in connection with any use of above information. Notwithstanding the foregoing, CHIMEI CORPORATION shall in no event be held obligated or liable for any claims due to or arising from (i) any customer provided, consigned, materials and/or parts, which are incorporated or adopted in the products; (ii) any combination of the products with material not provided or authorized by our company; (iii) any modifications to the products which are made or directed by customer; (iv) our compliance with the specifications, instructions, and/or designs provided by customer; (v) any anti-trust, unfair competition and/or other unlawful actions effected by customer; or (vi) any defects, infringement, breach and/or violation which are arising out of customer's faults or otherwise not solely and directly attributable to CHIMEI CORPORATION. In no event will CHIMEI CORPORATION be liable for any indirect, special, exemplary, punitive, or consequential damages (including lost profits) of any nature whatsoever whether arising out of the purchase, shipment, unloading, handling, or use of any product or otherwise.



- 25. 2-(2'-Hydroxy-3',5'-di-tert-butylphenyl)benzotriazole
- 26. Formaldehyde
- 56. PCTP (pentachlorothiophenol)
- 57. PFOA, PFOS, PFAS

With regard to composition of above grades of products, the aforesaid products comply with the Directives of RoHS (2011/65/EU), 2003/11/EC, TCO'07, Blue Angel and SONY Standard (SS-00259).

Sincerely Yours,



Perry D. B. Shiu
Vice President of R&D Division

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